

D2FK60

Fast Recovery Diodes

600V, 1.5A

Feature

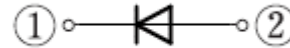
- Small SMD
- High Voltage
- Low Noise
- Available for automotive use
- Pb free terminal
- RoHS:Yes

OUTLINE

Package (House Name): 2F



Equivalent circuit



Absolute Maximum Ratings (unless otherwise specified : Tl=25°C)

Item	Symbol	Conditions	Ratings	Unit
Storage temperature	T _{stg}		-55 to 150	°C
Junction temperature	T _j		150	°C
Repetitive peak reverse voltage	V _{RRM}		600	V
Average forward current	I _{F(AV)}	50Hz sine wave, Resistance load, Tl=101°C	1.5	A
Average forward current	I _{F(AV)}	50Hz sine wave, Resistance load, On alumina substrate, Ta=30°C	1.1	A
Average forward current	I _{F(AV)}	50Hz sine wave, Resistance load, On glass-epoxy substrate, Ta=28°C	0.9	A
Surge forward current	I _{FSM}	50Hz sine wave, Non-repetitive 1 cycle, Peak value, Tj=25°C	40	A

※ :See the original Specifications

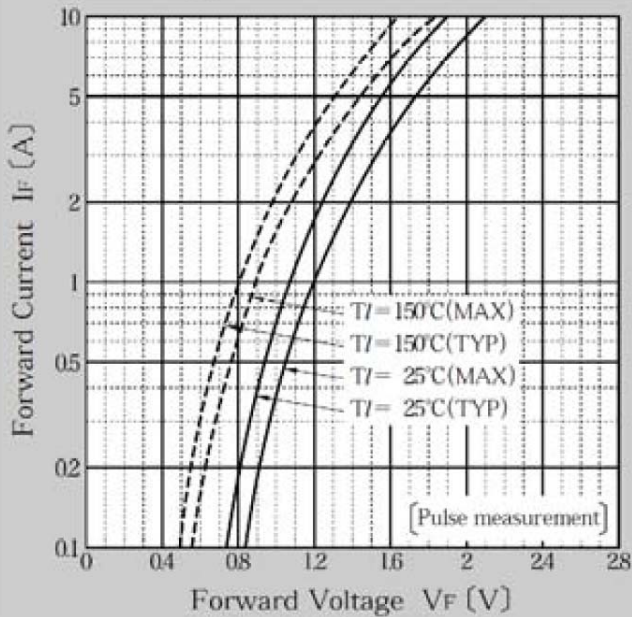
Electrical Characteristics (unless otherwise specified : Tl=25°C)

Item	Symbol	Conditions	Ratings			Unit
			MIN	TYP	MAX	
Forward voltage	V_F	$I_F=1.5A$, Pulse measurement			1.3	V
Reverse current	I_R	$V_R=600V$, Pulse measurement			10	μA
Reverse recovery time	t_{rr}	$I_F=0.5A$, $I_R=1.0A$, $0.25I_R$			75	ns
Total capacitance	C_t	$f=1MHz$, $V_R=10V$		16		pF
Thermal resistance	$R_{th(j-l)}$	Junction to lead			24	$^{\circ}C/W$
Thermal resistance	$R_{th(j-a)}$	Junction to ambient, On alumina substrate			90	$^{\circ}C/W$
Thermal resistance	$R_{th(j-a)}$	Junction to ambient, On glass-epoxy substrate			120	$^{\circ}C/W$

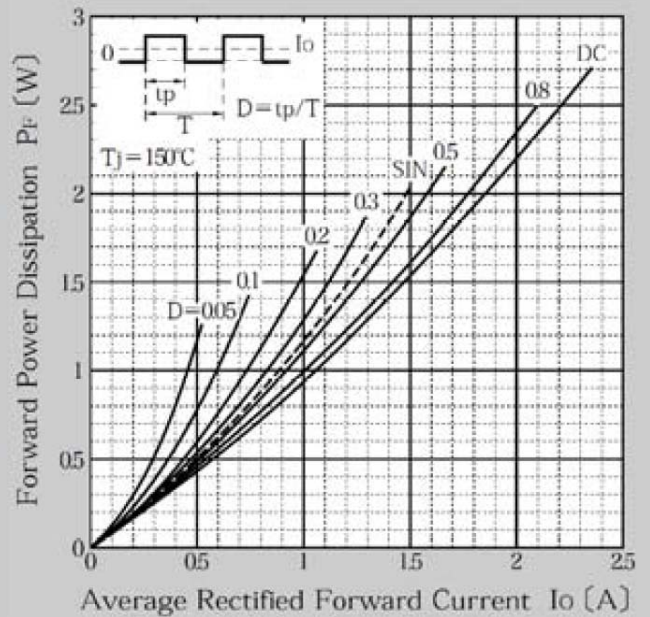
* :See the original Specifications

CHARACTERISTIC DIAGRAMS

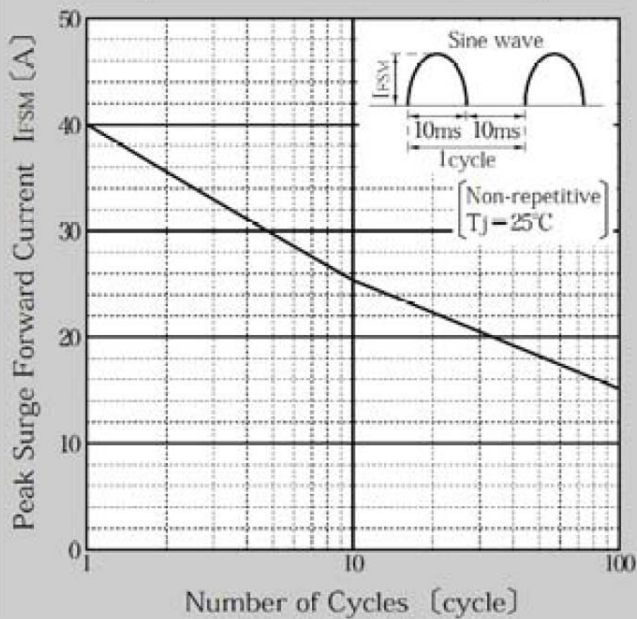
Forward Voltage



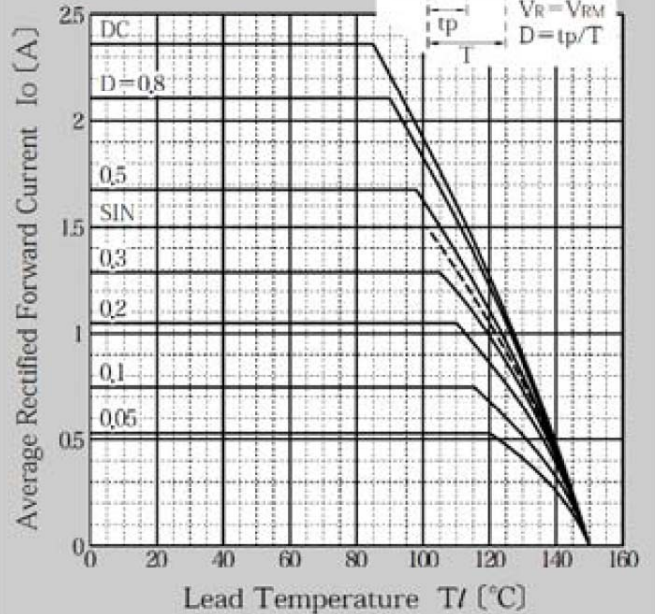
Forward Power Dissipation



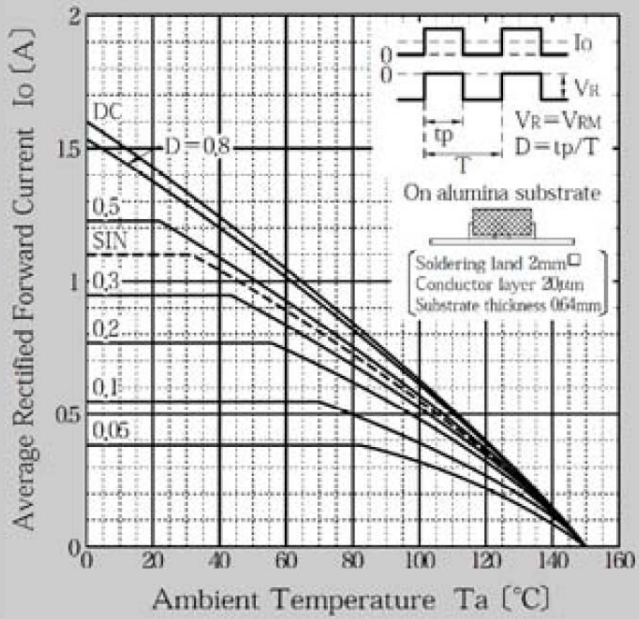
Peak Surge Forward Current Capability



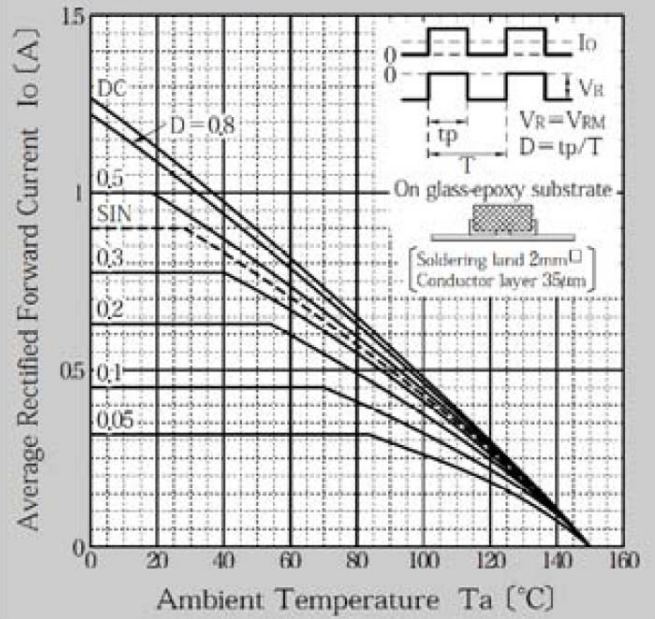
Derating Curve T_J - I_o



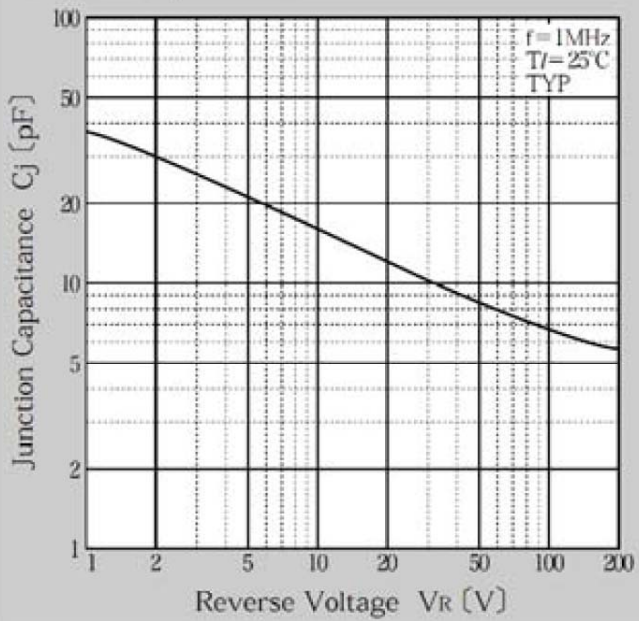
Derating Curve Ta-Io



Derating Curve Ta-Io

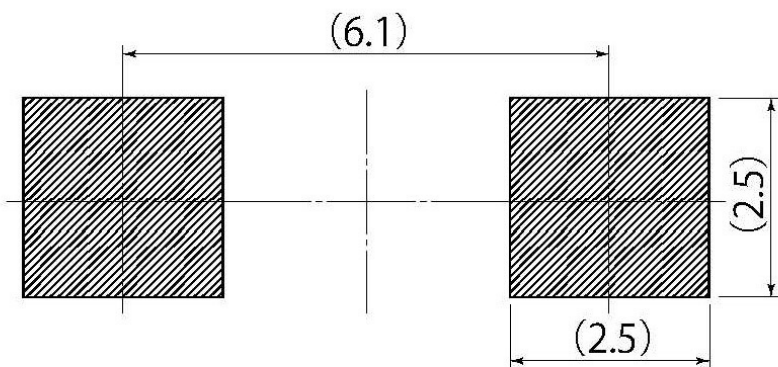
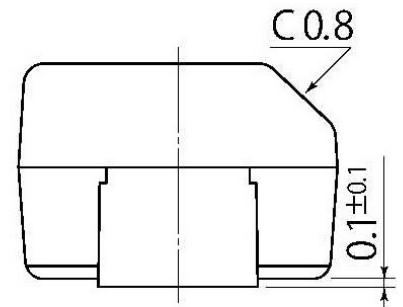
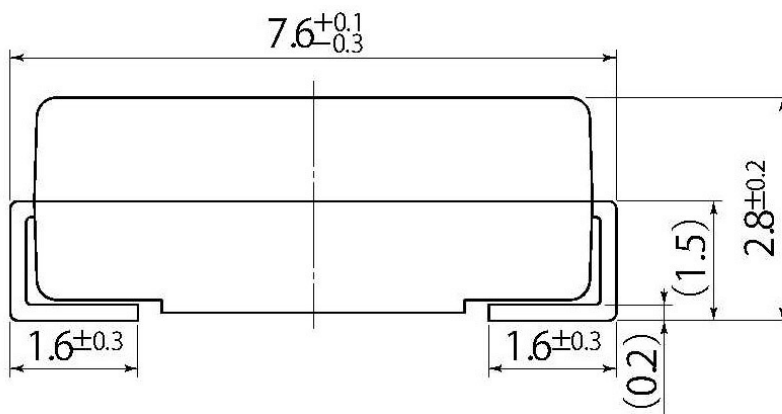
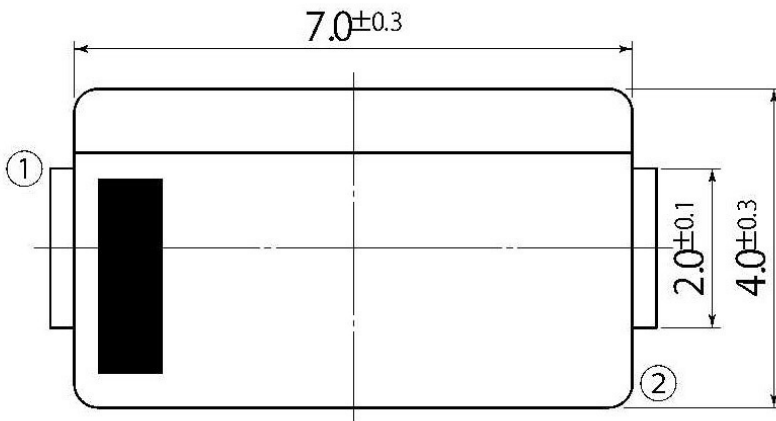


Junction Capacitance



B9

JEDEC Code	—
JEITA Code	—
House Name	2F



Referential Soldering Pad

• Optimize soldering pad to the board design and soldering condition.

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